		Day 1	Tuesday , May 13, 202	5 Technical Breakout Ses	ssions (each session is 35 n	nins presentation/Q&A + 10	Omins break/transit time)		
Time / Room	Room Guadalupe/4.208 HPD (120)	Room Fort Worth/4.308 APAMS (50)	Room Lavaca/4.204 5GMM (90)	Room Austin/4.408 TM (82)	Room Houston/4.314 TM (82)	Room Arlington/4.304 - T2000/HT(40)	Room Dallas/4.416 AI/TM (100)	Room El Paso/4.402 HPD(70)	Room Brazos (3F) 5G-RF(300)
8:00 AM					DME AND EVENT HIGHLIGHTS AND KEY		, (200,	(, _ ,	33 (332,
11:20 AM	10 - HPD	27 - APAMS	3 - 5G&RF	21 - TM	107 - TM	17 - T2000	151 - 5G&RF	160 - HPD	
	Pin Scale Multi-Level Serial (PS MLS) Re-Timed Loopback Development	Ultra-High-Precision DAC Test Solution at µV level with DC Scale AVI64	Cross Correlation EVM Method: Introduction and Implementation with V93000 Wave Scale RF	V93000 EXA Scale with Duo Interface Boosts AP Device Testing	Optimizing SmarTest 8 Specification Search for Test Time Reduction and Granular Result Precision	SIPM (LiDAR) Measurement Solution on T2000	Best Practice for Wi-Fi 6 Router Test Solution on the V93000 WSRF Platform	Revolutionizing DDR5 DIMM Chipset Testing: A New Era of Speed and Precision	
12:05 PM	76 - HPD	36 - APAMS	7 - 5G&RF	29 - TM	109 - TM	83 - T2000	159 - Al	185 - HPD	
	Power Integrity Design and Post- Verification for XPS256	High-Multi-Site, High-Voltage Test Solution for Power SIP Devices	Accurate RF Power Measurements with SmarTest	V93000 EXA Scale Latch-Up Testing of High-Power Devices	Lessons from Migrating to the V93000: 4.25X Faster, 2X Increased Parallelism	Toolchain to Convert Schematic Information for Use with T2000 IPSE Test Systems	Leveraging Generative AI for Domain-Specific Knowledge Retrieval and Interaction	Flow-Level CCT Solution for HPC Chips	
12:50 PM					LUNCH & EXPO				
2:00 PM	78 - HPD	69 - APAMS	18 - 5G&RF	28 - TM	114 - TM	154 - T2000	172 - Al	193 - HPD	
2.501 W	Boosting Scan-over-HSIO Implementation to 33Gbps with Pin Scale Multilevel Serial	SmarTest 8 Characterization Library Best Practices for ADAS Applications	Low-Cost, High-Efficiency ATE Test Solution for 5G RedCap Devices	Test Cost Optimization in SiP Product Development Through Efficient V93000 Concurrent Testing	Automating Testing Processes: Integrating Git, SSF API, ORE API, and SmartCI on Jenkins	Investigation of the Voltage Dependency of Standard Capacitors Using the Advantest T2000 IPSE	Predictive Test Selection for Silicon at System Level Using Machine Learning and Cloud Services	PinScale 5000 Protocol Link in SmarTest 8 Using Digital Pins as Embedded Protocol Interface	
2:45 PM	92 - HPD	81 - APAMS	59 - 5G&RF	50 - TM	119 - TM	91 - HT	207 - AI	199 - HPD	149 - 5G&RF
	Planning for Vector Memory Usage in the Chiplet Era	A High-Efficiency Smart TV Chip Test Solution on V93000 EXA Scale	HRP-UWB PHY Modulated Testing	Optimizing Multiple Clock Setup in SmarTest 8 for Optimal	Automated Digital-Pin Resource Sharing and Site Sequencing	ACS Nexus Enables ACS RTDI to	Streamlining Concurrent Test Flow Testing of AI Chips	Challenges of Migrating a High- Performance Compute Application	Optimize Efficiency with Parallel Test using the WSRF and Link Scale
		Test solution on Asson EVA scale		Throughput	Handled by SmarTest 8	Empower Data Feedforward/Feedback in Semiconductor Production	resting of Ar Chips	from XPS256 to XHC32	Cards
3:30 PM		Test solution on vestore EAA scale		·		Feedforward/Feedback in	resulting of At Chips		
		85 - APAMS	13 - 5G&RF	·	Handled by SmarTest 8	Feedforward/Feedback in	208 - TM	from XPS256 to XHC32	
3:30 PM 3:50 PM			13 - 5G&RF New Bluetooth Channel Sounding Production Testing on V93000	Throughput	Handled by SmarTest 8	Feedforward/Feedback in Semiconductor Production			
	95 - HPD Using Match Loop Features on Pin Scale 5000 to Develop AC Timing Measurements for New Protocols	85 - APAMS Low-Cost Charger Device Test Solution by using XP5128+HV on	New Bluetooth Channel Sounding	Throughput 38-TM TestStream: Software Framework for Automated Test Setup,	Handled by SmarTest 8 BREAK & EXPO 121 - TM Integrating SSN in Production Testing: Benefits and	Feedforward/Feedback in Semiconductor Production 135 - HT Testing Challenges and Low- Cost Test Solutions for 6nm Process RTOS Smartwatch	208 - TM Parametric Testing of HSIO Pads	from XPS256 to XHC32 205 - HPD Beyond X5R? Exploring Thermal Effects of High Temperature	
3:50 PM	95 - HPD Using Match Loop Features on Pin Scale 5000 to Develop AC Timing Measurements for New Protocols	85 - APAMS Low-Cost Charger Device Test Solution by using XP5128+HV on EXA Scale	New Bluetooth Channel Sounding Production Testing on V93000	Throughput 38 - TM TestStream: Software Framework for Automated Test Setup, Execution and Postprocessing	Handled by SmarTest 8 BREAK & EXPO 121 - TM Integrating SSN in Production Testing: Benefits and Implementation on SmartTest 8	Feedforward/Feedback in Semiconductor Production 135 - HT Testing Challenges and Low- Cost Test Solutions for 6mm Process RTOS Smartwatch Device	208 - TM Parametric Testing of HSIO Pads Without DC Access	from XPS256 to XHC32 205 - HPD Beyond XSR? Exploring Thermal Effects of High Temperature Testing	
3:50 PM	95 - HPD Using Match Loop Features on Pin Scale 5000 to Develop AC Timing Measurements for New Protocols 101 - HPD Best Practices for DC Scale UHC4T to XHC32 Migration	85 - APAMS Low-Cost Charger Device Test Solution by using XP5128+HV on EXA Scale 169 - APAMS Testing a High-Cell-Count BMS Device Using a Hybrid Cell Meter	New Bluetooth Channel Sounding Production Testing on V93000 43 - 5G&RF Maximizing Throughput with Next- Generation RF Instrument on the	38 - TM TestStream: Software Framework for Automated Test Setup, Execution and Postprocessing 32 - TM Test Challenges and Low-Cost Test Solutions for PMIC Development	Handled by SmarTest 8 BREAK & EXPO 121-1TM Integrating SSN in Production Testing: Benefits and Implementation on SmartTest 8 138-TM Best Practices for Transitioning Test Method Libraries from	Feedforward/Feedback in Semiconductor Production 135 - HT Testing Challenges and Low- Cost Test Solutions for 6nm Process RTOS Smartwatch Device 195 - HT Best Practices for Testing 800G	208 - TM Parametric Testing of HSIO Pads Without DC Access 214 - TM Test Power Debug and Characterization with SmartShell	from XPS256 to XHC32 205 - HPD Beyond XSR? Exploring Thermal Effects of High Temperature Testing 153 - HPD Silicon Photonics Optical Control	
3:50 PM	95 - HPD Using Match Loop Features on Pin Scale 5000 to Develop AC Timing Measurements for New Protocols 101 - HPD Best Practices for DC Scale UHC4T to XHC32 Migration	85 - APAMS Low-Cost Charger Device Test Solution by using XP5128+HV on EXA Scale 169 - APAMS Testing a High-Cell-Count BMS Device Using a Hybrid Cell Meter	New Bluetooth Channel Sounding Production Testing on V93000 43 - 5G&RF Maximizing Throughput with Next- Generation RF Instrument on the	38 - TM TestStream: Software Framework for Automated Test Setup, Execution and Postprocessing 32 - TM Test Challenges and Low-Cost Test Solutions for PMIC Development	Handled by SmarTest 8 BREAK & EXPO 121 - TM Integrating SSh in Production Testing: Benefits and Implementation on SmartTest 8 138 - TM Best Practices for Transitioning Test Method Libraries from SmartTest 7 to SmartTest 8	Feedforward/Feedback in Semiconductor Production 135 - HT Testing Challenges and Low- Cost Test Solutions for 6nm Process RTOS Smartwatch Device 195 - HT Best Practices for Testing 800G	208 - TM Parametric Testing of HSIO Pads Without DC Access 214 - TM Test Power Debug and Characterization with SmartShell	from XPS256 to XHC32 205 - HPD Beyond XSR? Exploring Thermal Effects of High Temperature Testing 153 - HPD Silicon Photonics Optical Control	

		Day 2	Wednesday, May 14, 20	025 Technical Breakout S	Sessions (each session is 35	mins presentation/Q&A + :	10mins break/transit time)	
Time / Room	Room Guadalupe/4.208	Room Fort Worth/4.308	Room Lavaca/4.204	Room Austin/4.408	Room Houston/4.314	Room Arlington/4.304 -	Room Dallas/4.416	Room El Paso/4.402
8:00 AM	HPD (120)	APAMS (50)	5GMM (90)	TM (82)	TM (82) WELCOME, KEYNOTE 2 AND BREAK	T2000/HT(40)	AI/TM (100)	HPD(70)
10:30 AM	111 - HPD Best Practices of Test Time Reduction and Memory Optimization for GPU Test Library on SmarTest 8	113 - APAMS XPS256 AWG and DGT with Xtreme Regulation Technology on Mixed-Signal Devices	15 - SG&RF Addressing High-Performance Analog Interface ADDA testing for Wi-Fi 7 Router	60 - TM Vmin to the Max: A New Approach to Single-Sequencer Run Searching	150 - TM Test Program Development Framework for Reduced Time-to- Market	155 - T2000 Efficiency Improvement Using RDK Assistant	190 - TM Vector Memory Toolset for SmarTest 8	145 - HPD Deep Learning Application for ADAS Testing with proteanTec at Exascale
11:15 AM	120 - HPD Practical Change Period Implementation for Scan Test Patterns with PSS000 CT Immediate + SmarTest 8	123 - APAMS Using Pin Scale 5000 C-DAC for Low-Cost Solution in High-Volume MCU Manufacturing	61 - SG&RF HRP-UWB Production Testing from WSRF to WSRF 20ex	72 - TM Boosting Efficiency and Security in Test Development with Podman on RHEL9	157 - TM Synopsys Streaming Fabric with Advantest V93000 ATE Support	196 - T2000 Advanced Accuracy in BMIC Chip Testing with High-Power Stack Integration	178 - TM Left-Shifting Functional Validation to Wafer Sort	112 - APAMS Best Practices Using Wave Scale MX for Current Sourcing Test
12:00 PM					LUNCH & EXPO			
1:30 PM	125 - HPD Strategies for Preventing Burned Probes on the V93000 EXA Scale Platform	126 - APAMS Automotive System Basis Chip CAN- FD Transceiver Test Solutions on V93000	99 - SG&RF Testing SparkLink Low Energy Access Mode on V93000	86 - TM Implementing TestFlow per Site in SmarTest 8	163 - TM SmarTest 8 Current and Voltage Profiling Techniques: Strategies, Use Cases and Best Practices	197 - T2000 Optimized Cost-Reduction Test Solutions for MCU, Sensor, and Driver ICs Using T2000-AIR	216 - TM Minimizing Test-Time Overhead When Using Slow Digital Protocols on EXA Scale PS5000	147 - APAMS Optimizing Test Time for Automotive Airbag Devices Using SmarTest 8
2:15 PM	129 - HPD A Scalable and Interactive Solution for Dynamic Shmoo Testing on HPC Devices in SmarTest 8	206 - APAMS Advanced Solution for SmarTest 8 PAC Complex Trimming and Comparator	143 - 5G&RF 5G RedCap Test Solution on V93000	98 - TM Improving DDR Yield by Performing Optimization on Input/Output Settings	165 - TM A Novel Approach to Functional Test Using SiConic without Requiring PSS	122 - FA Best Practices for Improving OEE of V93000 Final Test Cell in Production	194 - TM Real-Time UART Data Streaming and Logging on ATE for Enhanced Failure Analysis	171 - HSDI Enhance Search Speed by Utilizing Embedded CoGo in SmarTest 8
3:00 PM	132 - HPD Streamlined Shmoo Characterization Solution for Efficient GPU Pattern Bring-Up in SmarTest 8	167 - APAMS Accurate Differential Voltage Forcing Solution onto High- Reference Voltage with V93000	148 - 5G&RF From 200 MHz to 2 GHz – An Answer to UWB Test Challenges	104 - TM Streamlining SmarTest 8 Offline Result Emulation with Simplified Configuration Through Modular CSV Files	173 - TM Case Study: Fail Log Feedback to ATPG Scan Diagnostics and Solutions Fixing Cycle information	44 - HSDI Best Time-to-Quality Universal Inspection Solution Using SmarTest 8	203 - TM Development of Serial Buses in SmarTest 8 Using Utility Lines with Protocol Access Comparison	179 - HSDI Test Specification Management for Automatic Test Program Generation on SmarTest 8
3:45 PM					CLOSING AND AWARD CEREMONY			
[Al Artificial Intelligence	TM Test Methodology	5G&RF 5G/mmWave WSRF	FA Factory Automation	HSDI Hardware/Software Design Integration			
Topic Tracks	APAMS Automotive, Power, Analog and Mixed Signal	HT Hot Topics	HPD High Performance Digital	T2000 T2000				